# **ANALOG DEVICES**

# 256-Position, Ultralow Power 1.8 V Logic-Level Digital Potentiometer

# AD5165

### **FEATURES**

Ultralow standby power I<sub>DD</sub> = 50 nA typical 256-position End-to-end resistance 100 kΩ Logic high voltage 1.8 V Power supply 2.7 V to 5.5 V Low temperature coefficient 35 ppm/°C Compact thin 8-lead TSOT-8 (2.9 mm × 2.8 mm) package Simple 3-wire digital interface Wide operating temperature -40°C to +125°C Pin-to-pin compatible to AD5160 with CS inverted

### **APPLICATIONS**

Battery-operated electronics adjustment Remote utilities meter adjustment Mechanical potentiometer replacement Transducer circuit adjustment Automotive electronics adjustment Gain control and offset adjustment System calibration VCXO adjustment

### **GENERAL OVERVIEW**

The AD5165 provides a compact 2.9 mm  $\times$  2.8 mm packaged solution for 256-position adjustment applications. These devices perform the same electronic adjustment function as mechanical potentiometers or variable resistors, with enhanced resolution, solid-state reliability, and superior low temperature coefficient performance. The AD5165's supply voltage requirement is 2.7 V to 5.5 V, but its logic voltage requirement is 1.8 V to V<sub>DD</sub>. The AD5165 consumes very low quiescent power during standby mode and is ideal for battery-operated applications.

Wiper settings are controlled through a simple 3-wire interface. The interface is similar to the SPI<sup>®</sup> digital interface except for the inverted chip-select function that minimizes logic power consumption in the idling state. The resistance between the wiper and either endpoint of the fixed resistor varies linearly with respect to the digital code transferred into the wiper register.

Operating from a 2.7 V to 5.5 V power supply and consuming less than 50 nA typical standby power allows use in batteryoperated portable or remote utility device applications.

## FUNCTIONAL BLOCK DIAGRAM



## **PIN CONFIGURATION**



## **TYPICAL APPLICATION**



Note: The terms *digital potentiometer*, *RDAC*, and *VR* are used interchangeably.

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### **REVISION HISTORY**

4/04—Revision 0: Initial Version

## ELECTRICAL CHARACTERISTICS—100 kΩ VERSION

 $V_{DD}$  = 5 V ± 10%, or 3 V ± 10%;  $V_A$  =  $V_{DD}$ ;  $V_B$  = 0 V; -40°C <  $T_A$  < +125°C; unless otherwise noted.

Table 1.						
Parameter	Symbol	Conditions	Min	Typ <sup>1</sup>	Max	Unit
DC CHARACTERISTICS—RHEOSTAT MOD	E					
Resistor Differential Nonlinearity <sup>2</sup>	R-DNL	R <sub>WB</sub> , V <sub>A</sub> = no connect	-1	±0.1	+1	LSB
Resistor Integral Nonlinearity <sup>2</sup>	R-INL	R <sub>WB</sub> , V <sub>A</sub> = no connect	-2	±0.25	+2	LSB
Nominal Resistor Tolerance <sup>3</sup>	$\Delta R_{AB}/R_{AB}$	$T_A = 25^{\circ}C$	-20		+20	%
Resistance Temperature Coefficient	$(\Delta R_{AB}/R_{AB})/\Delta Tx10^{6}$	$V_{AB} = V_{DD}$ , wiper = no connect		35		ppm/°
Wiper Resistance	Rw	$V_{DD} = 2.7 \text{ V}/5.5 \text{ V}$		85/50	150/120	Ω
DC CHARACTERISTICS—POTENTIOMETER	R DIVIDER MODE					
Resolution	Ν				8	Bits
Differential Nonlinearity <sup>4</sup>	DNL		-1	±0.1	+1	LSB
Integral Nonlinearity <sup>4</sup>	INL		-1	±0.3	+1	LSB
Voltage Divider Temperature Coefficient	(ΔV <sub>W</sub> /V <sub>W</sub> )/ΔTx10 <sup>6</sup>	Code = 0x80		15		ppm/°
Full-Scale Error	V <sub>WFSE</sub>	Code = 0xFF	-0.5	-0.3	0	LSB
Zero-Scale Error	V <sub>wzse</sub>	Code = 0x00	0	0.1	0.5	LSB
RESISTOR TERMINALS						
Voltage Range⁵	V <sub>A,B,W</sub>		GND		V <sub>DD</sub>	V
Capacitance <sup>6</sup> A, B	C <sub>A,B</sub>	f = 1 MHz, measured to GND, Code = 0x80		90		pF
Capacitance <sup>6</sup> W	Cw	f = 1 MHz, measured to GND, Code = 0x80		95		pF
Common-Mode Leakage	Ісм	$V_A = V_B = V_{DD}/2$		1		nA
DIGITAL INPUTS AND OUTPUTS						
Input Logic High	VIH	$V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$	1.8			V
Input Logic Low	VIL	$V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$			0.6	v
Input Capacitance <sup>6</sup>	CIL			5		рF
POWER SUPPLIES						
Power Supply Range	V <sub>DD RANGE</sub>		2.7		5.5	V
Supply Current	IDD	Digital inputs = $0 V \text{ or } V_{DD}$		0.05	1	μA
		$V_{DD} = 2.7 V$ , digital inputs = 1.8 V		10		μA
		$V_{DD} = 5 V$ , digital inputs = 1.8 V		500		μA
Power Dissipation <sup>7</sup>	P <sub>DISS</sub>	Digital inputs = $0 \text{ V or } V_{DD}$			5.5	μW
Power Supply Sensitivity	PSS	$V_{DD} = +5 V \pm 10\%$ , Code = Midscale		±0.001	±0.005	%/%
DYNAMIC CHARACTERISTICS <sup>6, 8</sup>						
Bandwidth –3 dB	BW	Code = 0x80		55		kHz
Total Harmonic Distortion	THDw	$V_A = 1 V rms$ , $V_B = 0 V$ , $f = 1 kHz$ ,		0.05		%
V <sub>w</sub> Settling Time	ts	$V_A = 5 V, V_B = 0 V,$ ±1 LSB error band		2		μs
Resistor Noise Voltage Density	ел_wв	$R_{WB} = 50 \ k\Omega$		28		nV/√H:

<sup>&</sup>lt;sup>1</sup> Typical specifications represent average readings at +25°C and  $V_{DD} = 5$  V.

<sup>5</sup> Resistor terminals A, B, and W have no limitations on polarity with respect to each other.

<sup>6</sup> Guaranteed by design and not subject to production test.

 $^7$  P<sub>DISS</sub> is calculated from (I<sub>DD</sub> × V<sub>DD</sub>). CMOS logic level inputs result in minimum power dissipation.

<sup>8</sup> All dynamic characteristics use  $V_{DD} = 5$  V.

<sup>&</sup>lt;sup>2</sup> Resistor position nonlinearity error R-INL is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. R-DNL measures the relative step change from ideal between successive tap positions. Parts are guaranteed monotonic.

 $<sup>{}^{3}</sup>V_{AB} = V_{DD}$ , wiper (V<sub>W</sub>) = no connect.

<sup>&</sup>lt;sup>4</sup> INL and DNL are measured at  $V_W$  with the RDAC configured as a potentiometer divider similar to a voltage output D/A converter.  $V_A = V_{DD}$  and  $V_B = 0$  V.

## TIMING CHARACTERISTICS—100 k $\Omega$ version

 $V_{DD}$  = +5 V ± 10%, or +3 V ± 10%;  $V_A$  =  $V_{DD}$ ;  $V_B$  = 0 V; -40°C <  $T_A$  < +125°C; unless otherwise noted.

### Table 2.

Parameter	Symbol	Conditions	Min	Typ <sup>1</sup>	Мах	Unit
<b>3-WIRE INTERFACE TIMING CHARACTER</b>	RISTICS <sup>2, 3, 4</sup> (specifications ap	pply to all parts)				
Clock Frequency	$f_{CLK} = 1/(t_{CH} + t_{CL})$				25	MHz
Input Clock Pulse Width	tcн, tcl	Clock level high or low	20			ns
Data Setup Time	t <sub>Ds</sub>		5			ns
Data Hold Time	t <sub>DH</sub>		5			ns
CS Setup Time	t <sub>css</sub>		15			ns
CS Low Pulse Width	t <sub>csw</sub>		40			ns
CLK Fall to CS Rise Hold Time	t <sub>CSH0</sub>		0			ns
CLK Fall to CS Fall Hold Time	t <sub>CSH1</sub>		0			ns
CS Fall to Clock Rise Setup	t <sub>CS1</sub>		10			ns

<sup>&</sup>lt;sup>1</sup> Typical specifications represent average readings at +25°C and  $V_{DD} = 5$  V.

<sup>&</sup>lt;sup>2</sup> Guaranteed by design and not subject to production test. <sup>3</sup> All dynamic characteristics use  $V_{DD} = 5$  V.

<sup>&</sup>lt;sup>4</sup> See Figure 34 and Figure 35 for location of measured values. All input control voltages are specified with  $t_R = t_F = 2$  ns (10% to 90% of 3 V) and timed from a voltage level of 1.5 V.

## **ABSOLUTE MAXIMUM RATINGS**

 $T_A = +25^{\circ}C$ , unless otherwise noted.<sup>1,2</sup>

### Table 3.

Parameter	Value
V <sub>DD</sub> to GND	–0.3 V to +7 V
V <sub>A</sub> , V <sub>B</sub> , V <sub>W</sub> to GND	V <sub>DD</sub>
Maximum Current	
Iwb, Iwa Pulsed	±20 mA
$I_{WB}$ Continuous ( $R_{WB} \le 1 k\Omega$ , A open) <sup>2</sup>	±5 mA
$I_{WA}$ Continuous ( $R_{WA} \le 1 \text{ k}\Omega$ , B open) <sup>2</sup>	±5 mA
Digital Inputs and Output Voltage to GND	0 V to +7 V
Operating Temperature Range	-40°C to +125°C
Maximum Junction Temperature (T <sub>JMAX</sub> )	150°C
Storage Temperature	–65°C to +150°C
Lead Temperature (Soldering, 10 – 30 sec)	245°C
Thermal Resistance <sup>2</sup> θ <sub>JA</sub> : TSOT-8	200°C/W

<sup>1</sup> Maximum terminal current is bounded by the maximum current handling of the switches, maximum power dissipation of the package, and maximum applied voltage across any two of the A, B, and W terminals at a given resistance.

<sup>2</sup> Package power dissipation =  $(T_{JMAX} - TA)/\theta_{JA}$ .

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ESD CAUTION**

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



## **PIN CONFIGURATION AND FUNCTIONAL DESCRIPTIONS**



Table	4.	
Pin	Name	Description
1	W	Wiper terminal. $GND \le V_A \le V_{DD.}$
2	$V_{\text{DD}}$	Positive Power Supply.
3	GND	Digital Ground.
4	CLK	Serial Clock Input. Positive-edge triggered.
5	SDI	Serial Data Input (data loads MSB first).
6	CS	Chip Select Input, active high. When CS returns low, data is loaded into the wiper register.
7	В	B terminal. $GND \le V_A \le V_{DD}$ .
8	А	A terminal. $GND \le V_A \le V_{DD}$ .

04749-0-008

#### 0.5 0.5 5.5V 2.7V 0.4 0.4 POTENTIOMETER MODE DNL (LSB) 0.3 0.3 RHEOSTAT MODE INL (LSB) 0.2 0.2 0.1 0.1 0 0 -0.1 -0.1 -0.2 -0.2 -0.3 -0.3 -0.4 -0.4 -0.5 -0.5 04749-0-011 0 32 64 96 128 160 192 224 256 0 32 64 96 CODE (Decimal) Figure 5. R-INL vs. Code vs. Supply Voltages 0.5 0.5 -5.5V 0.4 0.4 -2.7V \_ POTENTIOMETER MODE INL (LSB) 0.3 0.3 REHOSTAT MODE DNL (LSB) 0.2 0.2 0.1 0.1 0 0 -0.1 -0.1 -0.2 -0.2 -0.3 -0.3 -0.4 -0.4 -0.5 -0.5 04749-0-013 32 160 192 32 0 64 96 128 224 256 0 64 96 CODE (Decimal) Figure 6. R-DNL vs. Code vs. Supply Voltages 0.5 0.5 -40°C 0.4 0.4 -40°C +25°C +85°C POTENTIOMETER MODE DNL (LSB) POTENTIOMETER MODE INL (LSB) 0.3 0.3 +125°C 0.2 0.2 0.1 0.1 0 0 -0.1 -0.1 -0.2 -0.2 -0.3 -0.3 -0.4 -0.4 -0.5 -0.5 04749-0-006 32 32 0 64 96 128 160 192 224 256 0 64 96 128 CODE (Decimal) CODE (Decimal)

## **TYPICAL PERFORMANCE CHARACTERISTICS**

Figure 7. INL vs. Code vs. Temperature ,  $V_{DD} = 5 V$ 

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-40°C +25°C +85°C +125°C 128 160 192 224 256 CODE (Decimal) Figure 8. DNL vs. Code vs. Temperature,  $V_{DD} = 5 V$ \_\_\_ 5.5V \_\_\_ 2.7V 128 160 192 224 256 CODE (Decimal) Figure 9. INL vs. Code vs. Supply Voltages 5.5V 2.7V

160

Figure 10. DNL vs. Code vs. Supply Voltages

192

224

256

04749-0-007

04749-0-009



Figure 16. Supply Current vs. Digital Input Voltage

04749-0-022

04749-0-020

04749-0-025

5



Figure 17. Supply Current vs. Digital Input Voltage



Figure 18. Rheostat Mode Tempco  $\Delta R_{WB}/\Delta T$  vs. Code



Figure 19. Potentiometer Mode Tempco ΔV<sub>WB</sub>/ΔT vs. Code



Figure 20. Gain vs. Frequency vs. Code,  $R_{AB} = 100 \text{ k}\Omega$ 



Figure 21. -3 dB Bandwidth @ Code = 0x80



Figure 22. PSRR vs. Frequency





Figure 26. Midscale Glitch, Code 0x80–0x7F

1 2 Ch 1 200mV B<sub>W</sub>Ch 2 5.00 V<sub>\b</sub>B<sub>W</sub>M100ns ACH2/3.00 V

Figure 24. Large Signal Settling Time, Code 0xFF-0x00



Figure 25. Digital Feedthrough

## **TEST CIRCUITS**

Figure 27 to Figure 33 illustrate the test circuits that define the test conditions used in the product specification tables.



Figure 27. Test Circuit for Potentiometer Divider Nonlinearity Error (INL, DNL)



Figure 28. Test Circuit for Resistor Position Nonlinearity Error (Rheostat Operation; R-INL, R-DNL)



Figure 29. Test Circuit for Wiper Resistance



Figure 30. Test Circuit for Power Supply Sensitivity (PSS, PSSR)



Figure 31. Test Circuit for Gain vs. Frequency



Figure 32. Test Circuit for Incremental ON Resistance



Figure 33. Test Circuit for Common-Mode Leakage Current

## **3-WIRE DIGITAL INTERFACE**

Note that in the AD5165 data is loaded MSB first.

### Table 5. AD5165 Serial Data-Word Format

B7	B6	B5	B4	B3	B2	B1	B0
D7	D6	D5	D4	D3	D2	D1	D0
MSB							LSB
27							2 <sup>0</sup>



Figure 34. 3-Wire Digital Interface Timing Diagram  $(V_A = 5 V, V_B = 0 V, V_W = V_{OUT})$ 



Figure 35. 3-Wire Digital Interface Detailed Timing Diagram ( $V_A = 5 V$ ,  $V_B = 0 V$ ,  $V_W = V_{OUT}$ )

## THEORY OF OPERATION

The AD5165 is a 256-position digitally controlled variable resistor (VR) device.

### PROGRAMMING THE VARIABLE RESISTOR *Rheostat Operation*

The nominal resistance of the RDAC between terminals A and B is available in 100 k $\Omega$ . The nominal resistance (R<sub>AB</sub>) of the VR has 256 contact points accessed by the wiper terminal, plus the B terminal contact. The 8-bit data in the RDAC latch is decoded to select one of the 256 possible settings.



Figure 36. Rheostat Mode Configuration

Assuming that a 100 k $\Omega$  part is used, the wiper's first connection starts at the B terminal for data 0x00. Because there is a 50  $\Omega$  wiper contact resistance, such a connection yields a minimum of 100  $\Omega$  (2 × 50  $\Omega$ ) resistance between terminals W and B. The second connection is the first tap point, which corresponds to 490  $\Omega$  ( $R_{WB} = R_{AB}/256 + 2 \times R_W = 390 \Omega + 2 \times 50 \Omega$ ) for data 0x01. The third connection is the next tap point, representing 880  $\Omega$  (2 × 390  $\Omega$  + 2 × 50  $\Omega$ ) for data 0x02, and so on. Each LSB data value increase moves the wiper up the resistor ladder until the last tap point is reached at 100,100  $\Omega$  ( $R_{AB} + 2 \times R_W$ ).



Figure 37. AD5165 Equivalent RDAC Circuit

The general equation determining the digitally programmed output resistance between W and B is

$$R_{WB}(D) = \frac{D}{256} \times R_{AB} + 2 \times R_W \tag{1}$$

where:

*D* is the decimal equivalent of the binary code loaded in the 8-bit RDAC register.

 $R_{AB}$  is the end-to-end resistance.

 $R_W$  is the wiper resistance contributed by the on resistance of the internal switch.

In summary, if  $R_{AB} = 100 \text{ k}\Omega$  and the A terminal is open circuited, the following output resistance  $R_{WB}$  is set for the indicated RDAC latch codes.

Table 6. Codes and Corresponding R<sub>WB</sub> Resistance

D (Dec.)	R <sub>WB</sub> (Ω)	Output State
255	99,710	Full scale ( $R_{AB}$ – 1 LSB + $R_W$ )
128	50,100	Midscale
1	490	1 LSB
0	100	Zero scale (wiper contact resistance)

Note that, in the zero-scale condition, a finite wiper resistance of 100  $\Omega$  is present. Care should be taken to limit the current flow between W and B in this state to a maximum pulse current of no more than 20 mA. Otherwise, degradation or possible destruction of the internal switch contact can occur.

Similar to the mechanical potentiometer, the resistance of the RDAC between the wiper W and terminal A also produces a digitally controlled complementary resistance,  $R_{WA}$ . When these terminals are used, the B terminal can be opened. Setting the resistance value for  $R_{WA}$  starts at a maximum value of resistance and decreases as the data loaded in the latch increases in value. The general equation for this operation is

$$R_{WA}(D) = \frac{256 - D}{256} \times R_{AB} + 2 \times R_{W}$$
(2)

For  $R_{AB} = 100 \text{ k}\Omega$  with the B terminal open circuited, the following output resistance  $R_{WA}$  is set for the indicated RDAC latch codes.

Table 7. Codes and	Corresponding	<b>R</b> <sub>WA</sub> Resistance
--------------------	---------------	-----------------------------------

D (Dec.)	R <sub>WA</sub> (Ω)	Output State	
255	490	Full scale	
128	50,100	Midscale	
1	99, 710	1 LSB	
0	100,100	Zero scale	

Typical device-to-device matching is process-lot dependent and may vary by up to  $\pm 20\%$ . Because the resistance element is processed in thin film technology, the change in  $R_{AB}$  with temperature has a very low 35 ppm/°C temperature coefficient.

### PROGRAMMING THE POTENTIOMETER DIVIDER Voltage Output Operation

The digital potentiometer easily generates a voltage divider at wiper-to-B and wiper-to-A proportional to the input voltage at A to B. Unlike the polarity of  $V_{DD}$  to GND, which must be positive, voltage across A to B, W to A, and W to B can be at either polarity.



Figure 38. Potentiometer Mode Configuration

If ignoring the effect of the wiper resistance for approximation, connecting the A terminal to 5 V and the B terminal to ground produces an output voltage at the wiper-to-B starting at 0 V up to 1 LSB less than 5 V. Each LSB of voltage is equal to the voltage applied across terminals A and B divided by the 256 positions of the potentiometer divider. The general equation defining the output voltage at V<sub>w</sub> with respect to ground for any valid input voltage applied to terminals A and B is

$$V_W(D) = \frac{D}{256} V_A + \frac{256 - D}{256} V_B \tag{3}$$

A more accurate calculation, which includes the effect of wiper resistance,  $V_W$ , is

$$V_{W}(D) = \frac{R_{WB}(D)}{R_{AB}} V_{A} + \frac{R_{WA}(D)}{R_{AB}} V_{B}$$
(4)

Operation of the digital potentiometer in the divider mode results in a more accurate operation over temperature. Unlike the rheostat mode, the output voltage is dependent mainly on the ratio of the internal resistors  $R_{WA}$  and  $R_{WB}$  and not the absolute values. Therefore, the temperature drift reduces to 15 ppm/°C.

### **3-WIRE SERIAL BUS DIGITAL INTERFACE**

The AD5165 contains a 3-wire digital interface (SDI, CS, and CLK). The 8-bit serial word must be loaded MSB first. The format of the word is shown in Table 5.

The positive-edge sensitive CLK input requires clean transitions to avoid clocking incorrect data into the serial input register. Standard logic families work well. If mechanical switches are used for product evaluation, they should be debounced by a flip-flop or other suitable means. When CS is high, the clock loads data into the serial register on each positive clock edge, as shown in Figure 34. The data setup and data hold times in the specifications table determine the valid timing requirements. The AD5165 uses an 8-bit serial input data register word that is transferred to the internal RDAC register when the CS line returns to logic low. Extra MSB bits are ignored.

## **ESD PROTECTION**

All digital inputs are protected with a series of input resistors and parallel Zener ESD structures, shown in Figure 39 and Figure 40. This applies to the digital input pins SDI, CLK, and CS.



Figure 39. ESD Protection of Digital Pins



Figure 40. ESD Protection of Resistor Terminals

### **TERMINAL VOLTAGE OPERATING RANGE**

The AD5165  $V_{DD}$  and GND power supply defines the boundary conditions for proper 3-terminal digital potentiometer operation. Supply signals present on terminals A, B, and W that exceed  $V_{DD}$  or GND are clamped by the internal forward-biased diodes, as shown in Figure 41.



Figure 41. Maximum Terminal Voltages Set by V<sub>DD</sub> and GND

### **POWER-UP SEQUENCE**

Because the ESD protection diodes limit the voltage compliance at terminals A, B, and W (see Figure 41), it is important to power  $V_{DD}$ /GND before applying any voltage to terminals A, B, and W; otherwise, the diode is forward biased such that  $V_{DD}$  is powered unintentionally and may affect the rest of the user's circuit. The ideal power-up sequence is in the following order: GND,  $V_{DD}$ , digital inputs, and then  $V_A$ ,  $V_B$ , and  $V_W$ . The relative order of powering  $V_A$ ,  $V_B$ ,  $V_W$ , and the digital inputs is not important as long as they are powered after  $V_{DD}$ /GND.

## LAYOUT AND POWER SUPPLY BYPASSING

It is good practice to employ compact, minimum lead length layout design. The leads to the inputs should be as direct as possible with a minimum conductor length. Ground paths should have low resistance and low inductance.

Similarly, it is also good practice to bypass the power supplies with quality capacitors for optimum stability. Supply leads to the device should be bypassed with disk or chip ceramic capacitors of 0.01  $\mu$ F to 0.1  $\mu$ F. Low ESR 1  $\mu$ F to 10  $\mu$ F tantalum or electrolytic capacitors should also be applied at the supplies to minimize any transient disturbance and low frequency ripple (see Figure 42). Note that the digital ground should also be joined remotely to the analog ground at one point to minimize the ground bounce.



Figure 42. Power Supply Bypassing

## **EVALUATION BOARD**

An evaluation board, along with all necessary software, is available to program the AD5165 from any PC running Windows\* 98/2000/XP. The graphical user interface, as shown in Figure 43, is straightforward and easy to use. More detailed information is available in the user manual, which comes with the board.



Figure 43. AD5165 Evaluation Board Software

The AD5165 starts at midscale upon power-up. To increment or decrement the resistance, the user may move the scroll bars on the left. To write any specific value, the user should use the bit pattern in the upper screen and click the Run button. The format of writing data to the device is shown in Figure 32.

## **OUTLINE DIMENSIONS**



COMPLIANT TO JEDEC STANDARDS MO-193BA

Figure 44. 8-Lead Thin Small Outline Transistor Package [Thin SOT-23] (UJ-8) Dimensions shown in millimeters

### **ORDERING GUIDE**

Model	R <sub>AB</sub> (Ω)	Temperature	Package Description	Package Option	Quantity on Reel	Branding
AD5165BUJZ100-R21	100 k	-40°C to +125°C	Thin SOT-23	UJ-8	250	D3N
AD5165BUJZ100-R71	100 k	-40°C to +125°C	Thin SOT-23	UJ-8	3,000	D3N
AD5165EVAL			Evaluation Board			

 $^{1}$  Z = Pb-free part.

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